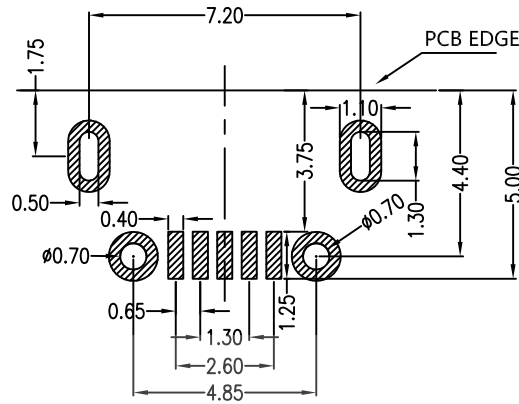
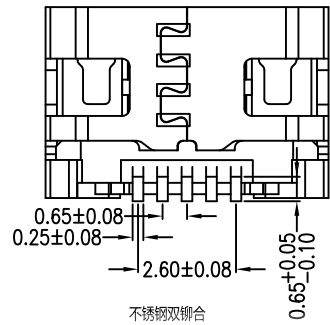
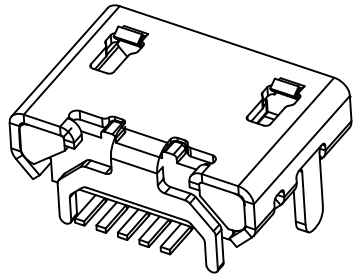


REV.	ECN NO.	CONTENT	DATE	ENGINEER
AO			2023 20/04	



PCB图仅供参考

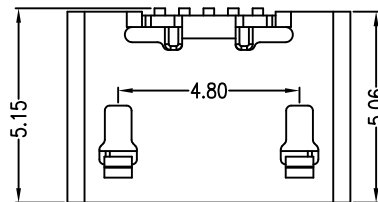
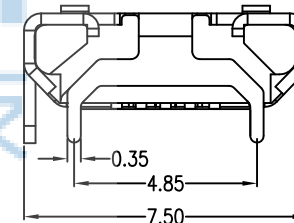
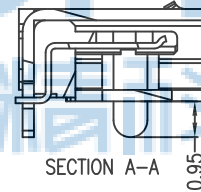
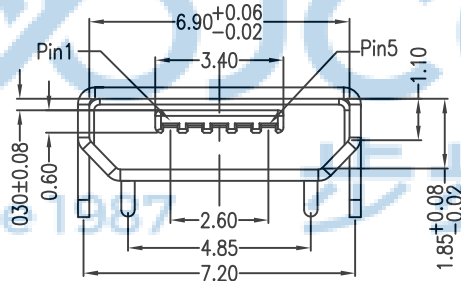
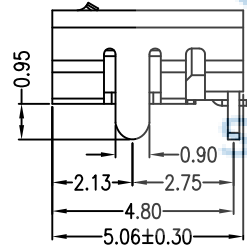
Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: SUS304,t=0.30mm

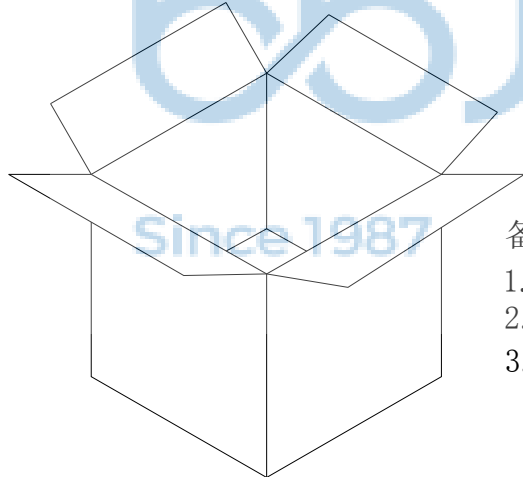
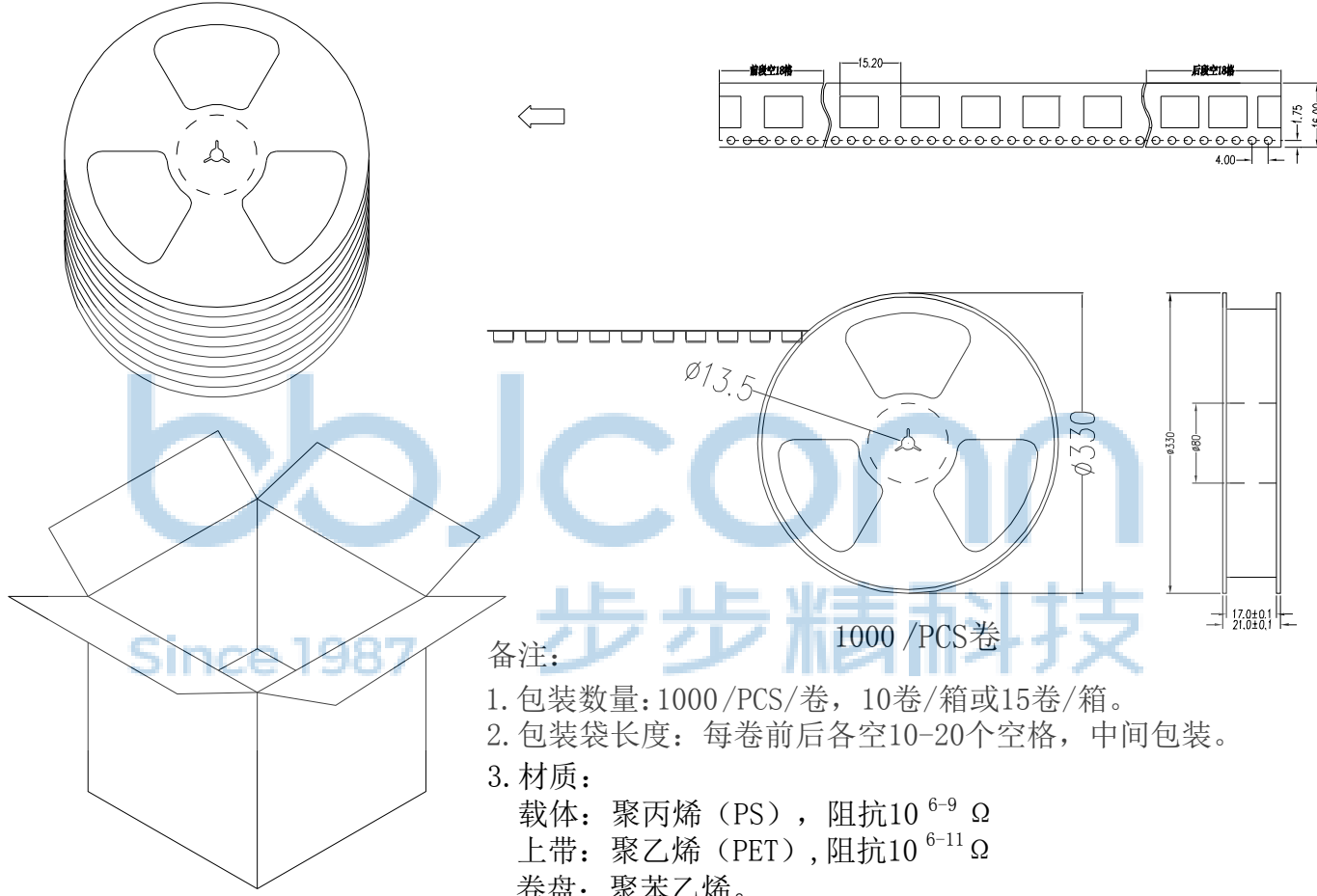
2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C



THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司	
APPD.	JM_Zheng	23/05'02	NAME: Micro-5P母座 小牛角 L=5.06 固定脚距7.2 牛角脚距4.8 平口不锈钢外壳
CHKD.	LYX	23/05'02	PJ. NO.: MC.01.62-11-1002
PDWG.NO:	0113-1	DR.	SGF
		23/05'02	SIZE: A4 DRW NO.:
			FINISH: SEE NOTES MAT'L.: SEE NOTES
			SCALE: N/A REV.: A3 UNIT: mm PAGE: 1/1

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0			2023 20/04	



备注：
1. 包装数量：1000 /PCS 卷，10卷/箱或15卷/箱。
2. 包装袋长度：每卷前后各空10-20个空格，中间包装。
3. 材质：
载体：聚丙烯（PS），阻抗 $10^{6-9} \Omega$
上带：聚乙烯（PET），阻抗 $10^{6-11} \Omega$
卷盘：聚苯乙烯。
纸箱规格：345*345*23MM
纸箱规格：345*345*35MM



THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司 .X: ±0.38 .X': ±3" .XX: ±0.25 .X'': ±2" .XXX: ±0.13 .XX': ±1"		NAME: Micro-5P母座 小牛角L=5.06 固定脚距7.2 牛角脚距4.8 平口不锈钢外壳 PJ. NO.: MC.01.62-11-1002 SIZE: A4 DRW NO.: FINISH: SEE NOTES MAT'L.: SEE NOTES SCALE: N/A REV.: A3 UNIT: mm PAGE: 1/1	
APPD.	JM_Zheng 23/05'02				
CHKD.	LYX 23/05'02				
PDWG.NO:	0113-1	DR.	SGF 23/05'02		